High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology

VSMY294310RG VSMY294310G

FEATURES

- Package type: surface mount
- Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- Peak wavelength: λ_p = 940 nm
- High reliability
- High radiant power
- Very high radiant intensity
- Angle of half intensity: φ = ± 25°
- Suitable for high pulse current operation
- Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series
- Floor life: 4 weeks, MSL 2a, acc. J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
e3
RoHS COMPLIANT
HALOGEN FREE
GREEN (5-2008)

DESCRIPTION

As part of the SurfLight™ portfolio, the VSMY294310 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- Miniature light barrier
- Photointerrupters
- Optical switch
- Emitter source for proximity sensors
- IR illumination

PRODUCT SUMMARY

COMPONENT	I_e (mW/sr)	φ (deg)	λ_p (nm)	t_r (ns)
VSMY294310RG	25	± 25	940	10
VSMY294310G	25	± 25	940	10

Note

- Test conditions see table “Basic Characteristics“

ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMY294310RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing
VSMY294310G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Reverse voltage		V_R	5	V
Forward current		I_F	70	mA
Surge forward current	t_p = 100 µs	I_{FSM}	1	A
Power dissipation		P_V	140	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	-40 to +85	°C
Storage temperature range		T_{stg}	-40 to +100	°C
Soldering temperature	Acc. figure 7, J-STD-020	T_{sd}	260	°C
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R_{thJA}	250	K/W

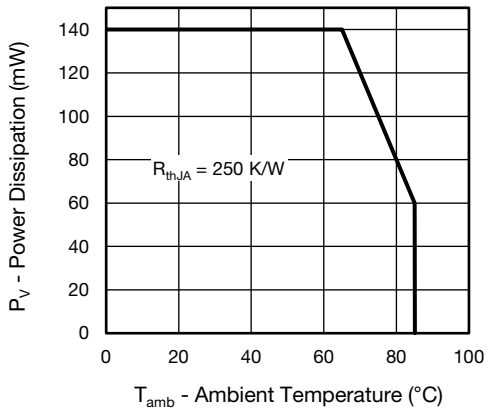


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

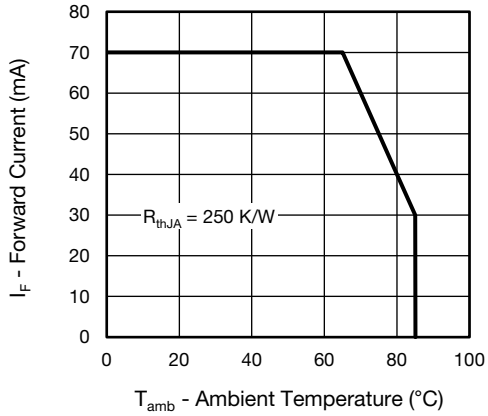


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Forward voltage	I_F = 70 mA, t_p = 20 ms	V_F	-	1.5	2.0	V
	I_F = 1 A, t_p = 100 µs	V_F	-	2.5	-	V
Temperature coefficient of V_F	I_F = 20 mA	TK_{VF}	-	-1.7	-	mV/K
Reverse current		I_R	not designed for reverse operation			µA
Junction capacitance	V_R = 0 V, f = 1 MHz, E = 0 mW/cm²	C_J	-	5	-	pF
Radiant intensity	I_F = 70 mA, t_p = 20 ms	I_e	12	25	45	mW/sr
	I_F = 1 A, t_p = 100 µs	I_e	-	260	-	mW/sr
Radiant power	I_F = 70 mA, t_p = 20 ms	ϕ_e	-	40	-	mW
Temperature coefficient of radiant power	I_F = 70 mA	$TK\phi_e$	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 25	-	deg
Peak wavelength	I_F = 20 mA	λ_p	920	940	960	nm
Spectral bandwidth	I_F = 20 mA	$\Delta\lambda$	-	35	-	nm
Temperature coefficient of λ_p	I_F = 20 mA	$TK\lambda_p$	-	0.25	-	nm/K
Rise time	I_F = 70 mA, 20 % to 80 %	t_r	-	10	-	ns
Fall time	I_F = 70 mA, 20 % to 80 %	t_f	-	10	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

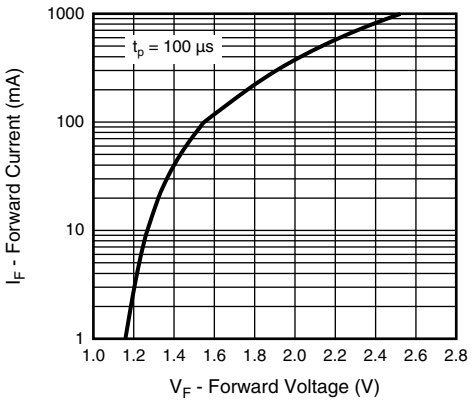


Fig. 3 - Forward Current vs. Forward Voltage

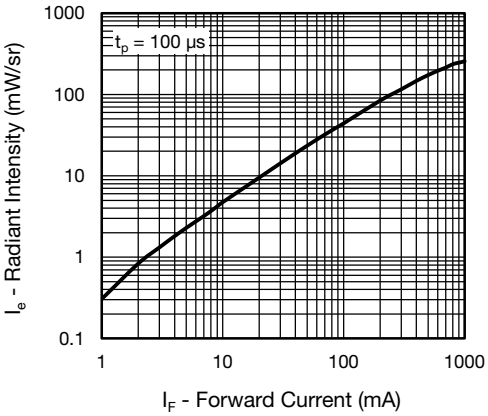


Fig. 6 - Radiant Intensity vs. Forward Current

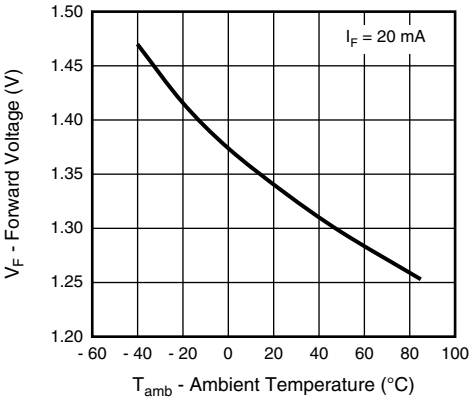


Fig. 4 - Forward Voltage vs. Ambient Temperature

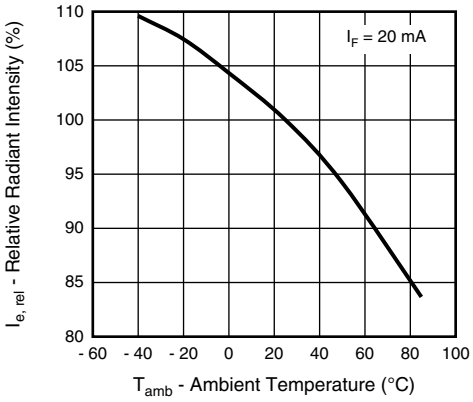


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

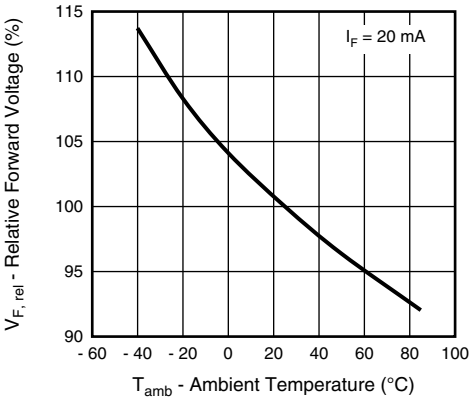


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

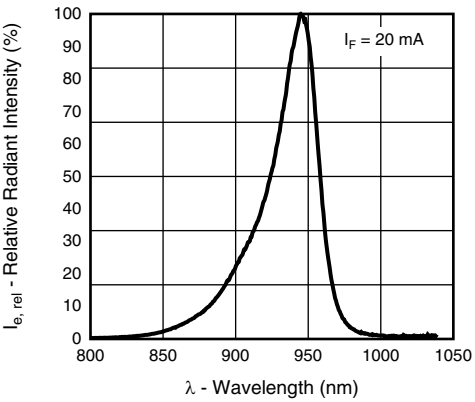


Fig. 8 - Relative Radiant Intensity vs. Wavelength

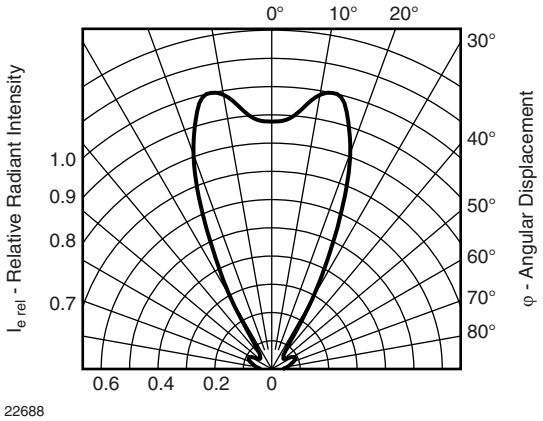


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

SOLDER PROFILE

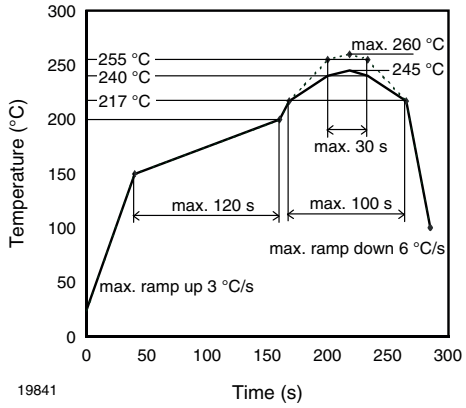


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

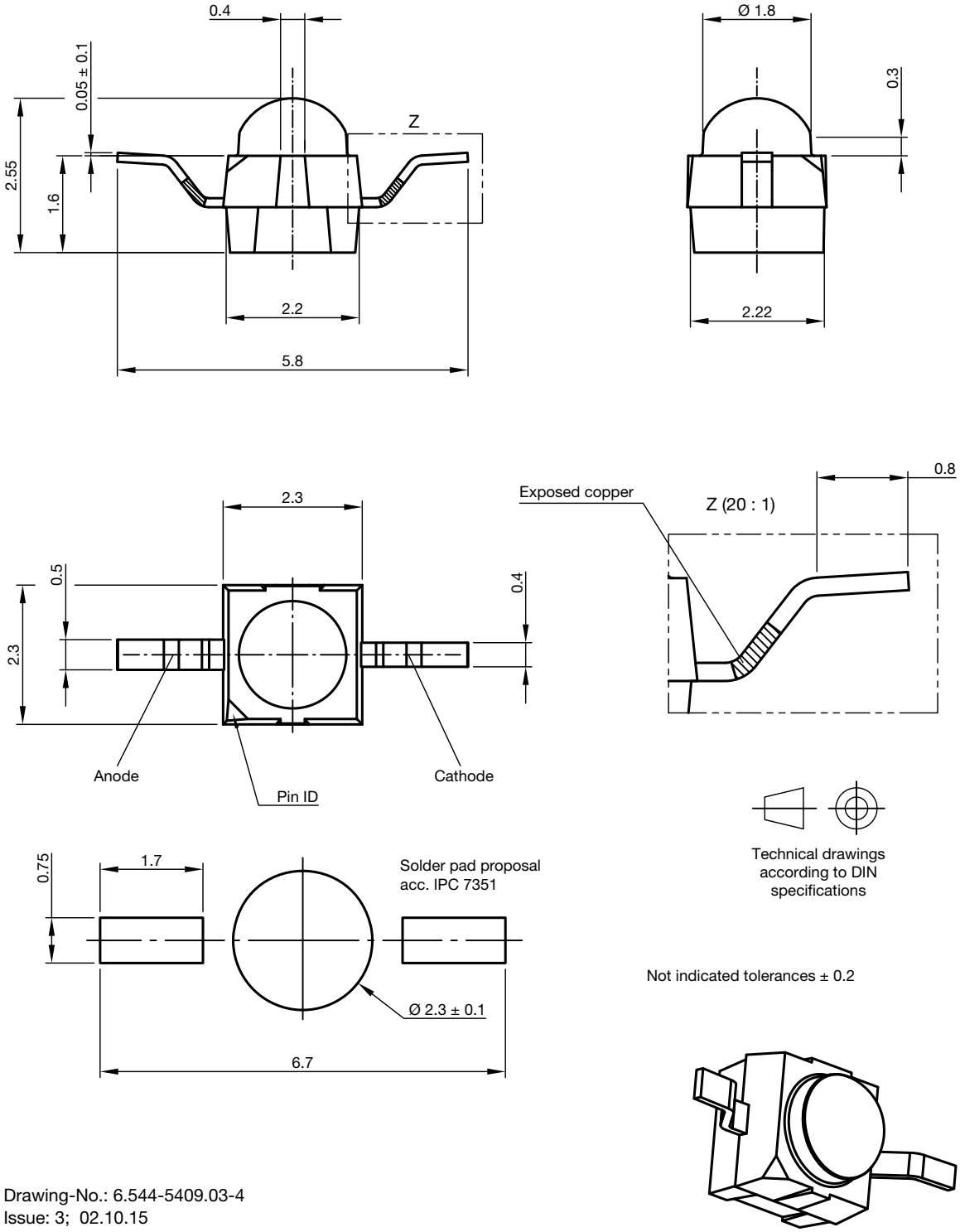
Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, acc. to J-STD-020.

DRYING

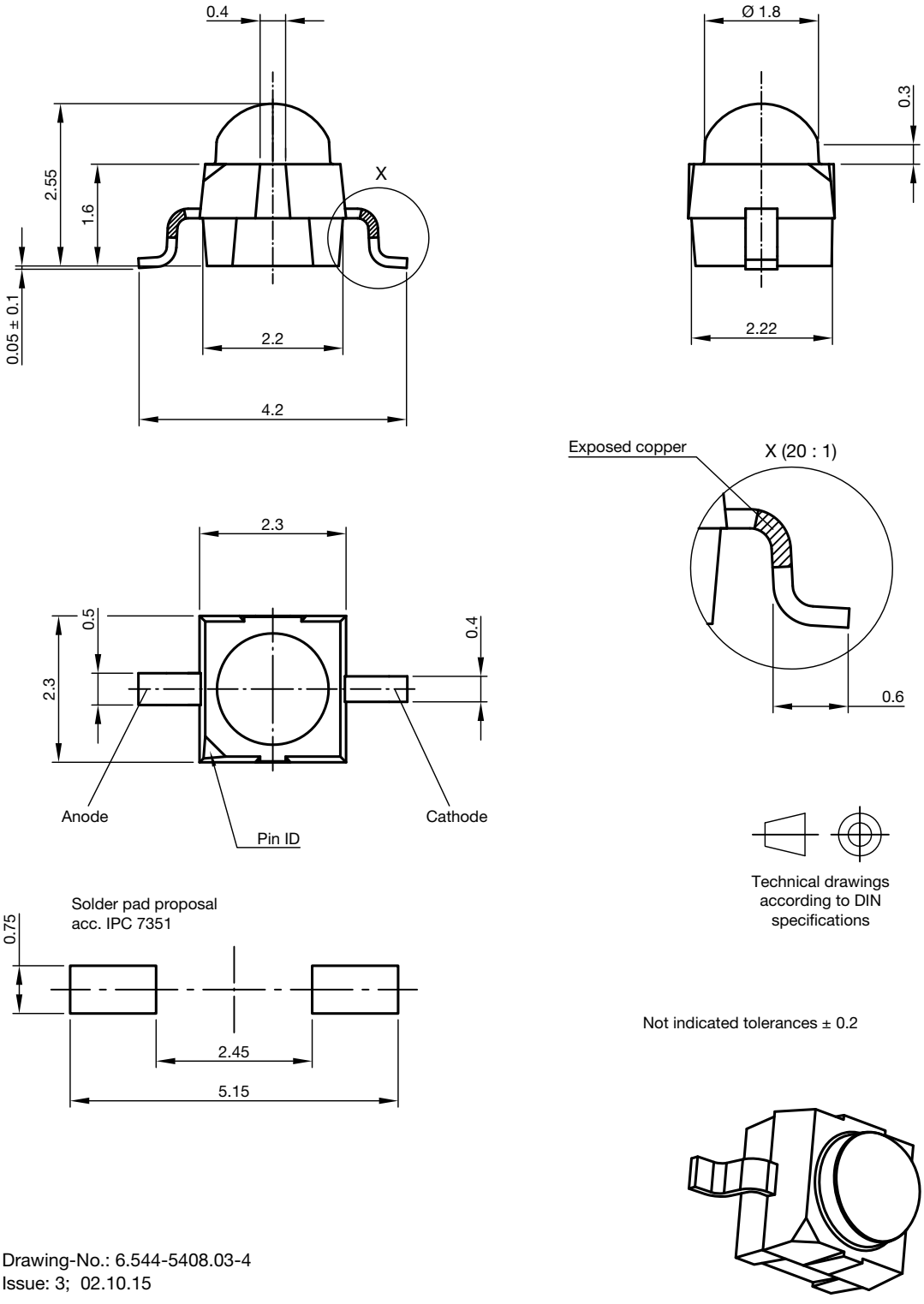
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENSIONS in millimeters: **VSMY294310RG**



Drawing-No.: 6.544-5409.03-4
Issue: 3; 02.10.15

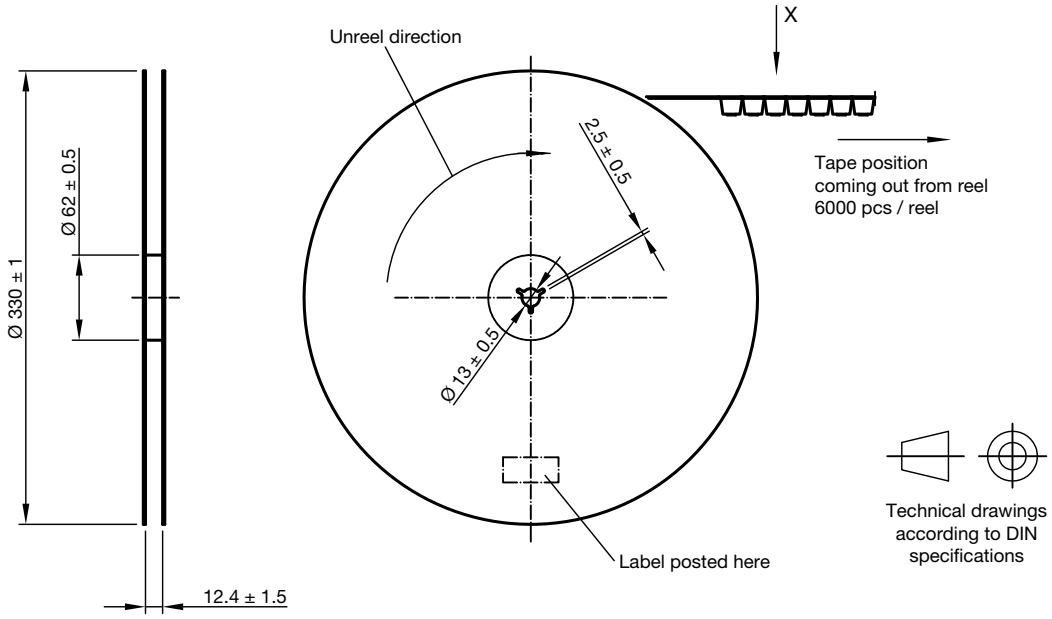
PACKAGE DIMENSIONS in millimeters: **VSMY294310G**



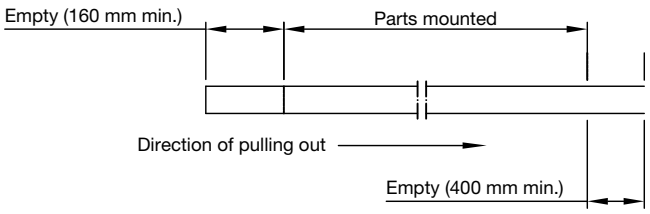
Drawing-No.: 6.544-5408.03-4
Issue: 3; 02.10.15

TAPING AND REEL DIMENSIONS in millimeters: **VSMY294310RG**

Reel

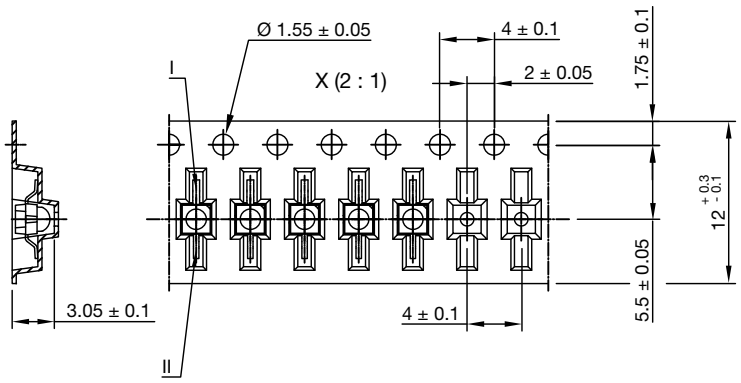


Leader and trailer tape



Terminal position in tape

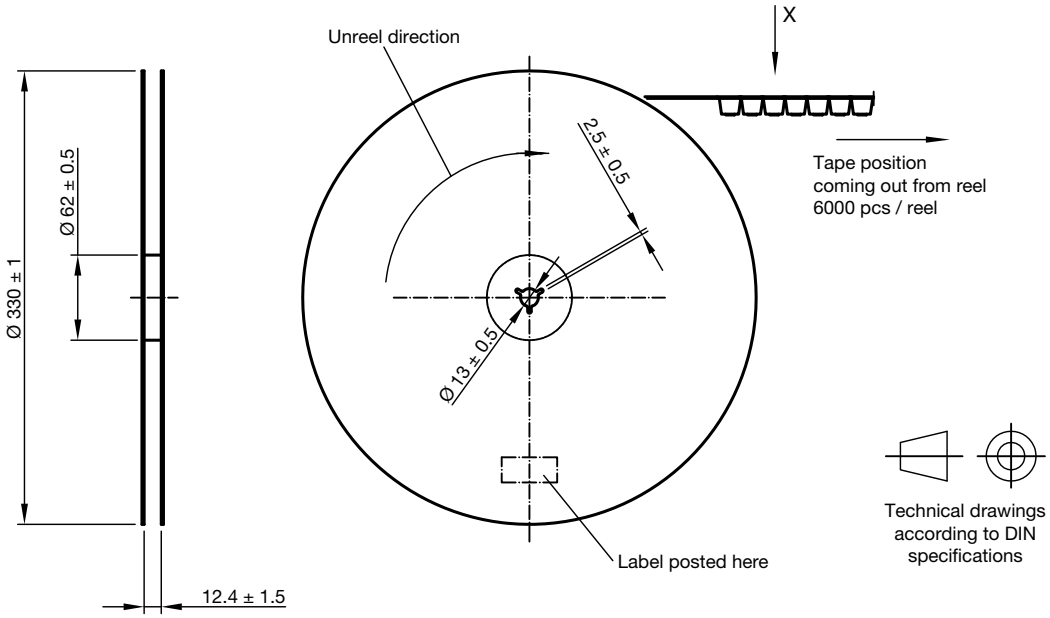
Device	Lead I	Lead II
VSMB2943RGX01	Cathode	Anode
VSMF2893RGX01		
VEMD2x03X01		
VEMT2x03X01	Collector	Emitter
VSMY2853RG	Anode	Cathode
VSMY2943RG		
VSMY294310RG		



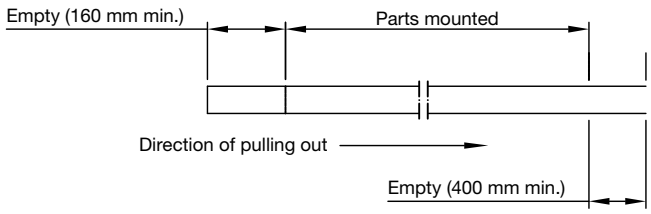
Drawing-No.: 9.800-5100.02-4
Issue: 3; 02.10.15

TAPING AND REEL DIMENSIONS in millimeters: **VSMY294310G**

Reel

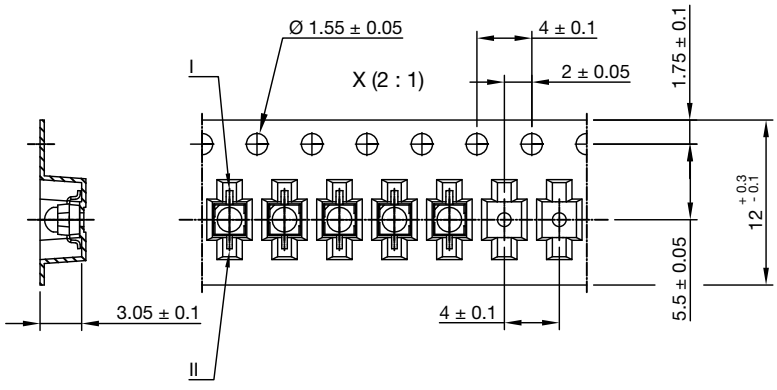


Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II
VSMB2943GX01	Cathode	Anode
VSMF2893GX01		
VEMD2x23X01		
VEMT2x23X01	Collector	Emitter
VSMY2853G	Anode	Cathode
VSMY2943G		
VSMY294310G		



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Issue: 3; 02.10.15

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